

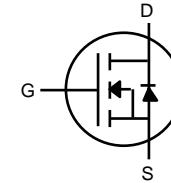
## HFB1N60S 600V N-Channel MOSFET

### FEATURES

- Originative New Design
- Superior Avalanche Rugged Technology
- Robust Gate Oxide Technology
- Very Low Intrinsic Capacitances
- Excellent Switching Characteristics
- Unrivalled Gate Charge : 3.0 nC (Typ.)
- Extended Safe Operating Area
- Lower  $R_{DS(ON)}$  : 10 Ω (Typ.) @ $V_{GS}=10V$
- 100% Avalanche Tested

$BV_{DSS} = 600 V$   
 $R_{DS(on)\ typ} = 10 \Omega$   
 $I_D = 0.3 A$

TO-92



### Absolute Maximum Ratings $T_C=25^\circ C$ unless otherwise specified

Symbol	Parameter	Value	Units
$V_{DSS}$	Drain-Source Voltage	600	V
$I_D$	Drain Current – Continuous ( $T_C = 25^\circ C$ )	0.3	A
	Drain Current – Continuous ( $T_C = 100^\circ C$ )	0.18	A
$I_{DM}$	Drain Current – Pulsed	(Note 1)	A
$V_{GS}$	Gate-Source Voltage	$\pm 30$	V
$E_{AS}$	Single Pulsed Avalanche Energy	(Note 2)	mJ
$I_{AR}$	Avalanche Current	(Note 1)	A
$E_{AR}$	Repetitive Avalanche Energy	(Note 1)	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$	(Note 3)	V/ns
$P_D$	Power Dissipation ( $T_A = 25^\circ C$ )	0.9	W
	Power Dissipation ( $T_L = 25^\circ C$ )	2.5	W
	- Derate above $25^\circ C$	0.02	W/ $^\circ C$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ C$
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	$^\circ C$

### Thermal Resistance Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JL}$	Junction-to-Lead	--	50	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient	--	140	

**Electrical Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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**On Characteristics**

$V_{GS}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$	2.0	--	4.0	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$ , $I_D = 0.15 \text{ A}$	--	10	12	$\Omega$

**Off Characteristics**

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	600	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.6	--	$\text{V}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}$ , $V_{GS} = 0 \text{ V}$	--	--	1	$\mu\text{A}$
		$V_{DS} = 480 \text{ V}$ , $T_C = 125^\circ\text{C}$	--	--	10	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}$ , $V_{DS} = 0 \text{ V}$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}$ , $V_{DS} = 0 \text{ V}$	--	--	-100	nA

**Dynamic Characteristics**

$C_{iss}$	Input Capacitance	$V_{DS} = 25 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1.0 \text{ MHz}$	--	130	170	pF
$C_{oss}$	Output Capacitance		--	22	29	pF
$C_{rss}$	Reverse Transfer Capacitance		--	5.0	6.5	pF

**Switching Characteristics**

$t_{d(on)}$	Turn-On Time	$V_{DS} = 300 \text{ V}$ , $I_D = 1.0 \text{ A}$ , $R_G = 25 \Omega$  (Note 4,5)	--	7	24	ns
$t_r$	Turn-On Rise Time		--	21	52	ns
$t_{d(off)}$	Turn-Off Delay Time		--	13	36	ns
$t_f$	Turn-Off Fall Time		--	27	64	ns
$Q_g$	Total Gate Charge	$V_{DS} = 480 \text{ V}$ , $I_D = 1.0 \text{ A}$ , $V_{GS} = 10 \text{ V}$  (Note 4,5)	--	3.0	4.0	nC
$Q_{gs}$	Gate-Source Charge		--	0.5	--	nC
$Q_{gd}$	Gate-Drain Charge		--	1.3	--	nC

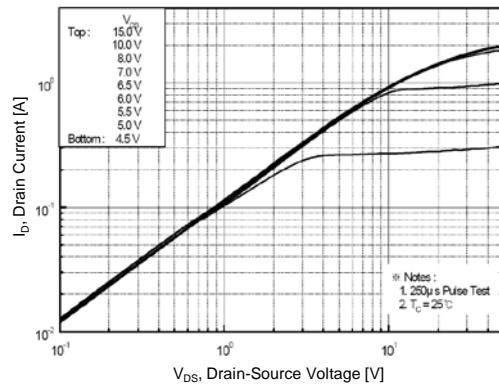
**Source-Drain Diode Maximum Ratings and Characteristics**

$I_S$	Continuous Source-Drain Diode Forward Current	--	--	0.3	A	
$I_{SM}$	Pulsed Source-Drain Diode Forward Current	--	--	1.2		
$V_{SD}$	Source-Drain Diode Forward Voltage	$I_S = 0.3 \text{ A}$ , $V_{GS} = 0 \text{ V}$	--	--	1.4	V
$trr$	Reverse Recovery Time	$I_S = 1.0 \text{ A}$ , $V_{GS} = 0 \text{ V}$ $di_F/dt = 100 \text{ A}/\mu\text{s}$ (Note 4)	--	190	--	ns
$Qrr$	Reverse Recovery Charge		--	0.53	--	$\mu\text{C}$

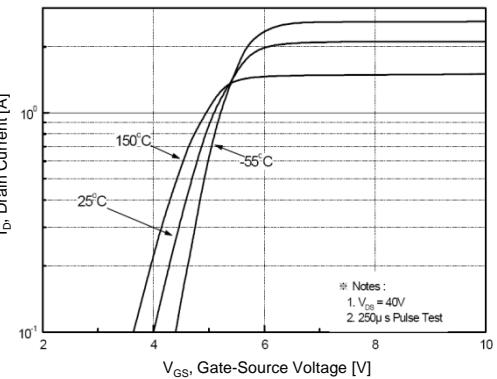
**Notes :**

- Repetitive Rating : Pulse width limited by maximum junction temperature
- $L=59\text{mH}$ ,  $I_{AS}=1.0\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
- $I_{SD}\leq 0.3\text{A}$ ,  $di/dt\leq 200\text{A}/\mu\text{s}$ ,  $V_{DD}\leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$
- Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$
- Essentially Independent of Operating Temperature

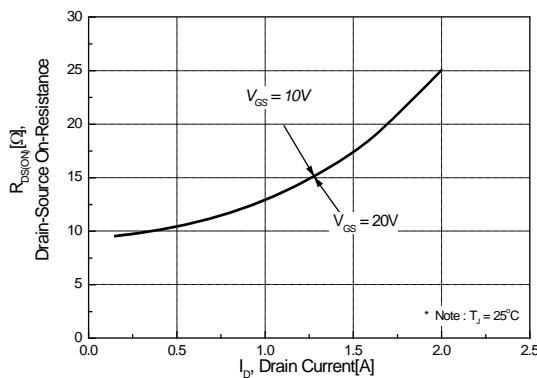
## Typical Characteristics



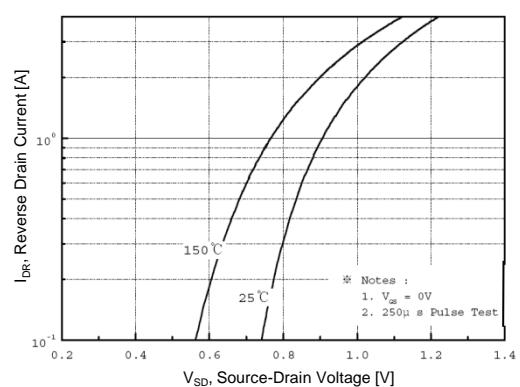
**Figure 1. On Region Characteristics**



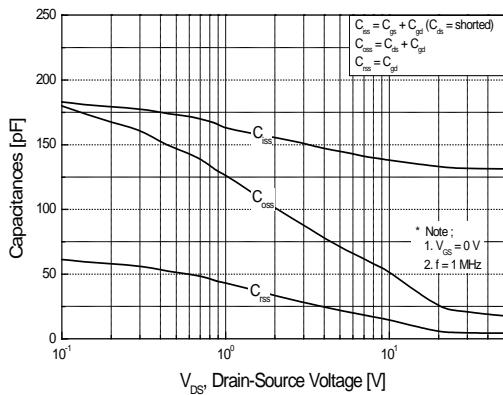
**Figure 2. Transfer Characteristics**



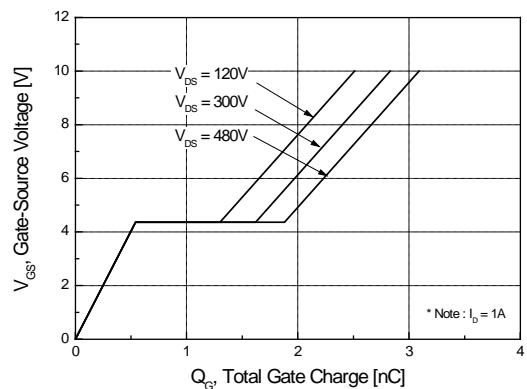
**Figure 3. On Resistance Variation vs. Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**

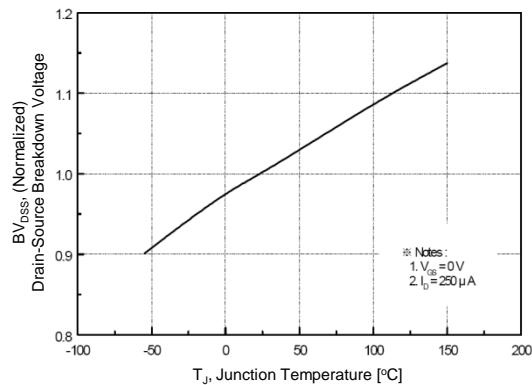


**Figure 5. Capacitance Characteristics**

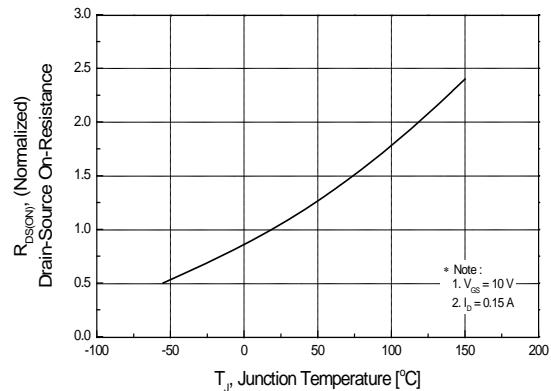


**Figure 6. Gate Charge Characteristics**

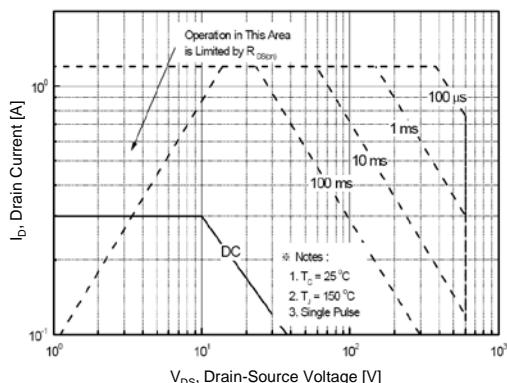
## Typical Characteristics (continued)



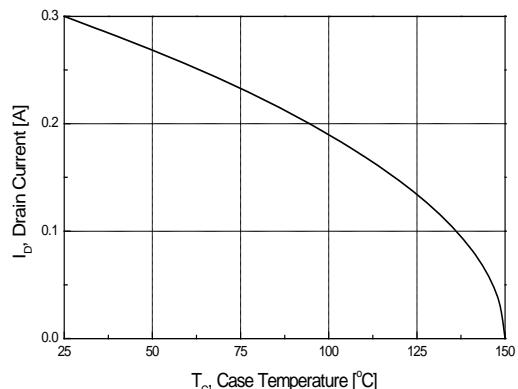
**Figure 7. Breakdown Voltage Variation vs Temperature**



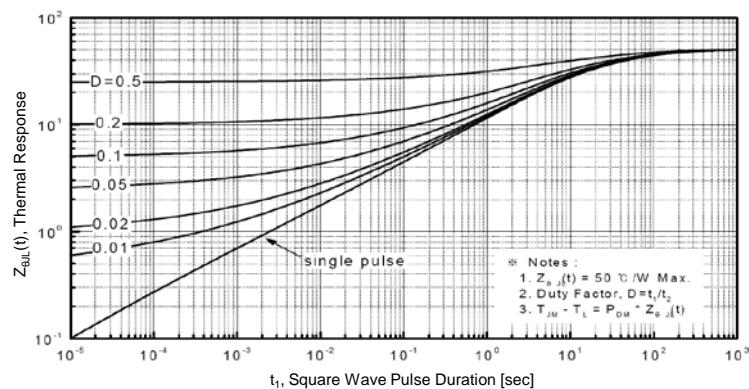
**Figure 8. On-Resistance Variation vs Temperature**



**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs Case Temperature**



**Figure 11. Transient Thermal Response Curve**

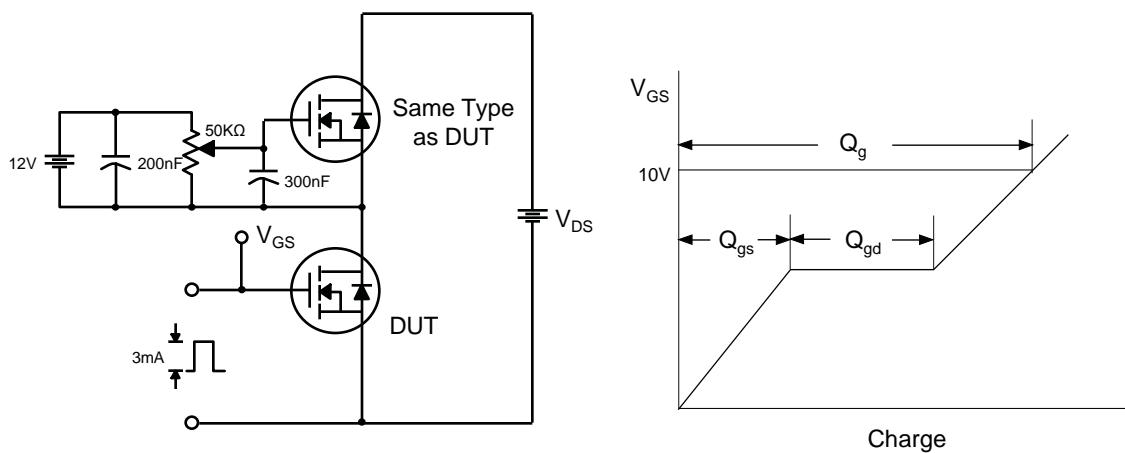
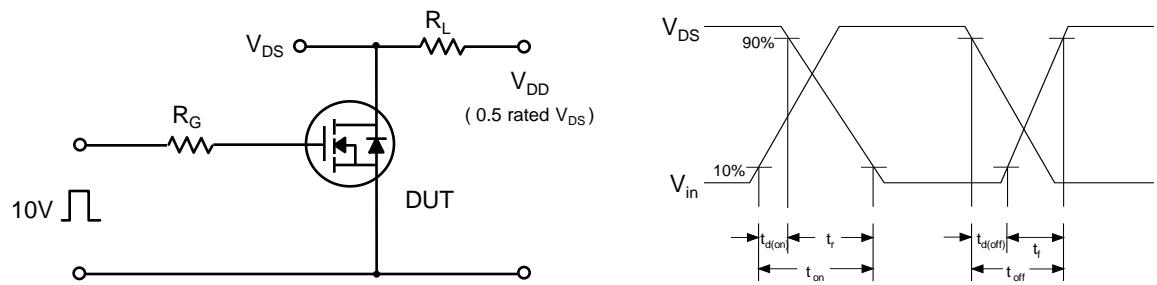
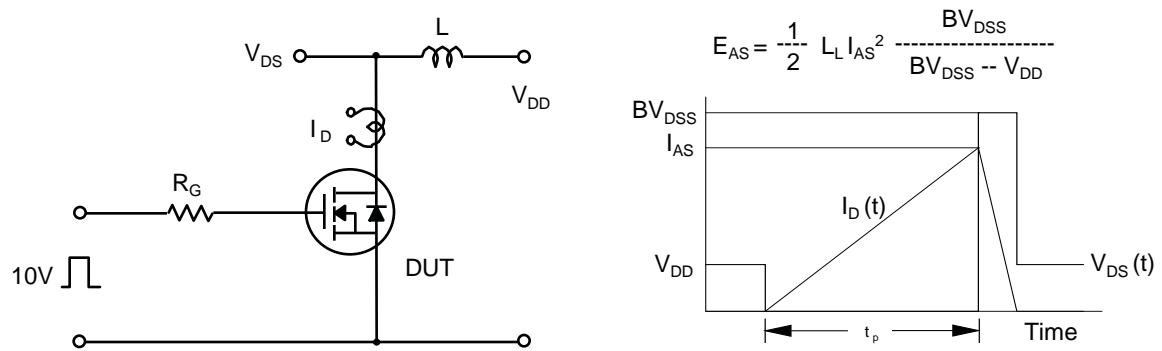
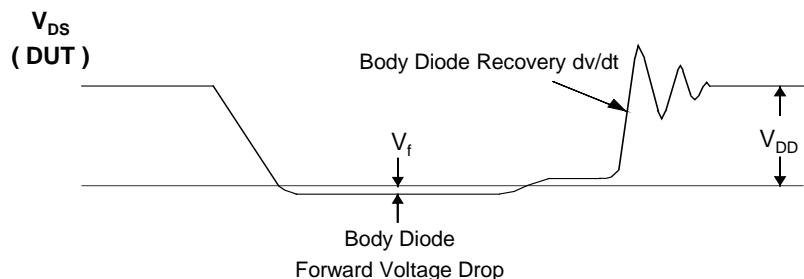
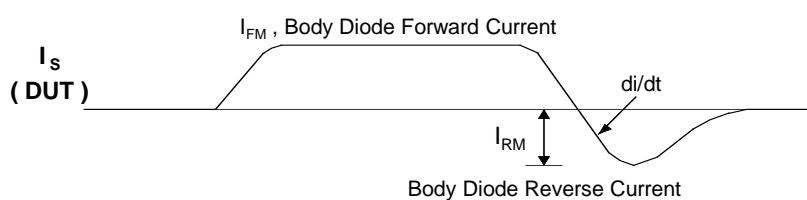
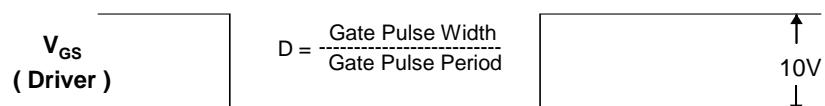
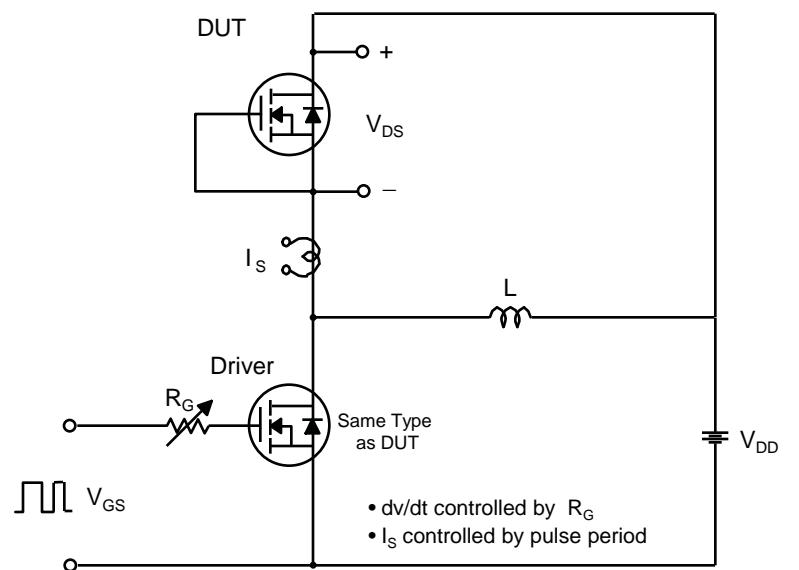
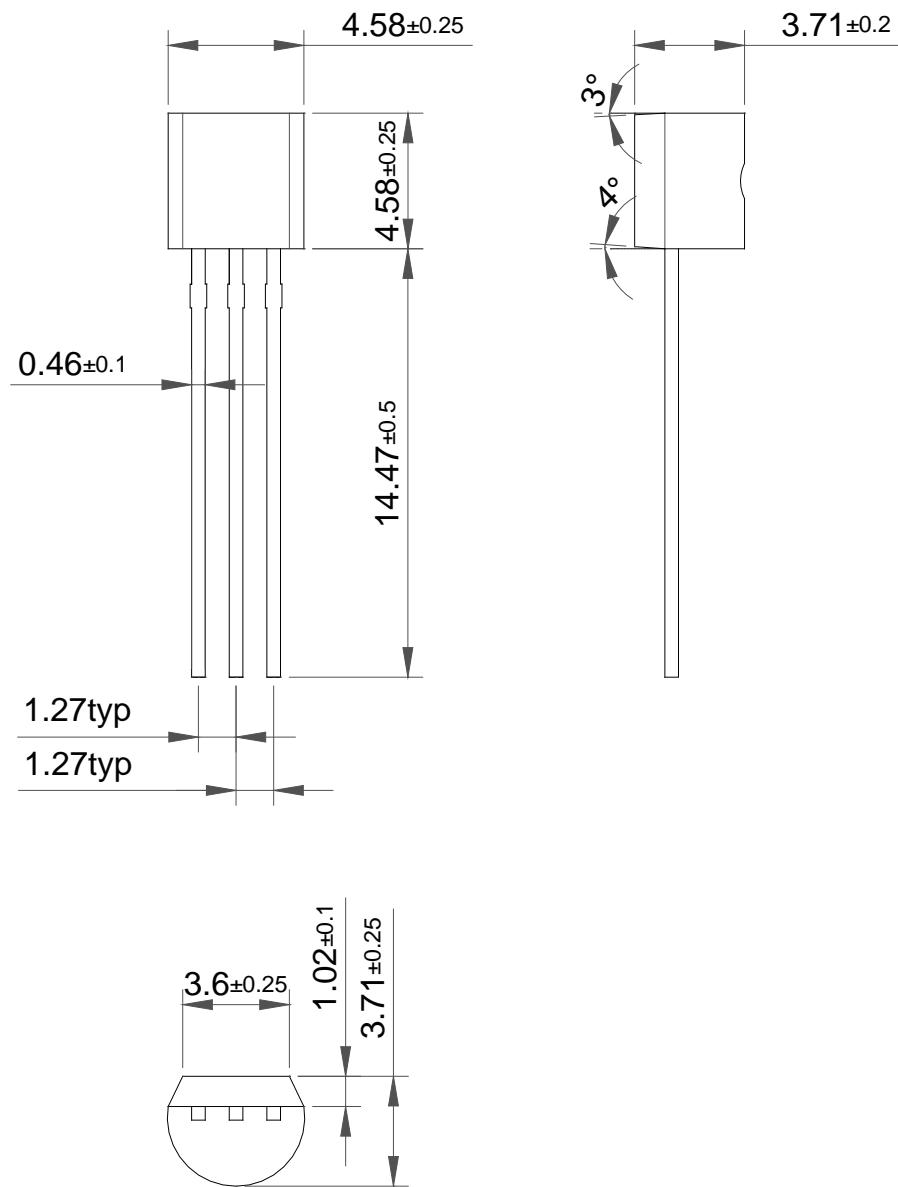
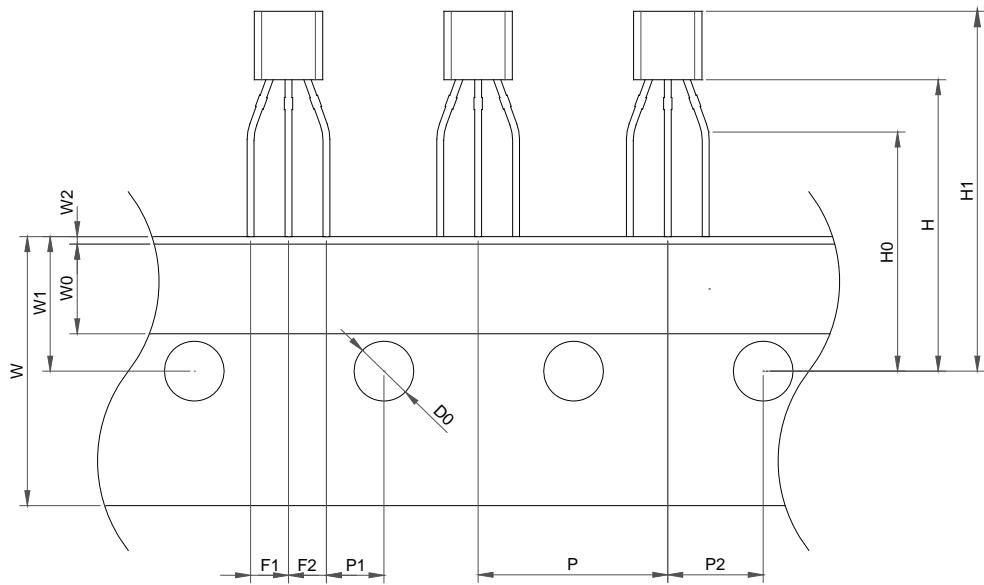
**Fig 12. Gate Charge Test Circuit & Waveform****Fig 13. Resistive Switching Test Circuit & Waveforms****Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms**

Fig 15. Peak Diode Recovery dv/dt Test Circuit &amp; Waveforms



**Package Dimension****TO-92**

## TO-92 TAPING



Item	Symbol	Dimension [mm]	
		Reference	Tolerance
Component pitch	P	12.7	$\pm 0.5$
Side lead to center of feed hole	P1	3.85	$\pm 0.5$
Center lead to center of feed hole	P2	6.35	$\pm 0.5$
Lead pitch	F1,F2	2.5	+0.2/-0.1
Carrier Tape width	W	18.0	+1.0/-0.5
Adhesive tape width	W0	6.0	$\pm 0.5$
Tape feed hole location	W1	9.0	$\pm 0.5$
Adhesive tape position	W2	1.0 MAX	
Center of feed hole to bottom of component	H	19.5	$\pm 1$
Center of feed hole to lead form	H0	16.0	$\pm 0.5$
Component height	H1	27.0 max	
Tape feed hole diameter	D0	4.0	$\pm 0.2$